PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kazuhiro Bessho	09/22/2011
Masanori Hosomi	09/26/2011
Hiroyuki Ohmori	09/26/2011
Yutaka Higo	09/22/2011
Kazutaka Yamane	09/22/2011
Hiroyuki Uchida	09/22/2011

RECEIVING PARTY DATA

Name:	Sony Corporation
Street Address:	1-7-1 Konan, Minato-ku
City:	Tokyo
State/Country:	JAPAN

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	13217925	

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	3712174-02856	

Total Attachments: 2

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> PATENT REEL: 027171 FRAME: 0988

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Attorney Docket No. 3712174-2856 SONY Ref. No.: S11P1626US00

ASSIGNMENT

WHEREAS. I. as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in MEMORY ELEMENT AND MEMORY DEVICE

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries:

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense:

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

the spaces that follow: Serial Number:	• • •	па арриса	Filing Date: August 25, 2011
This assignment executed on the dates indic	ated below.		
KAZUHIRO BESSHO			
Name of first or sole inventor KANAGAWA JAPAN			Execution date of U.S. Patent Application
Residence of First or sole inventor Kayakur Mersho			Date of this assignment
Signature of first or sole inventor			Date of this assignment
MASANORI HOSOMI		•	
Name of second inventor TOKYO JAPAN		٠	Execution date of U.S. Patent Application
Residence of second inventor			Sept. 26, 2011
Signature of second inventor			Date of this assignment
HIROYUKI OHMORI			
Name of third inventor KANAGAWA JAPAN	<u>,</u>	•	Execution date of U.S. Patent Application
Residence of third inventor	N 10	·	Solvho 26, 2011
Signature of third inventor		9	Date of this assignment

PATENT REEL: 027171 FRAME: 0989

ADDITIONAL INVENTOR(S)

YUTAKA HIGO	
Name of fourth inventor	Execution date of U.S. Patent Application
KANAGAWA JAPAN	
Residence of fourth inventor	0.1 22 2011
1x Jutition page	Date of this assignment
Signature of fourth inventor	Date of this assignment
KAZUTAKA YAMANE	The state of the s
Name of fifth inventor	Execution date of U.S. Patent Application
KANAGAWA JAPAN	
Residence of fifth inventor	0.57 22 2011
(x plazitato Jamone	Date of this assignment
Signature of fifth in entor	Date of this assignment
THEOMINITICHES	
HIROYUKI UCHIDA Name of sixth inventor	Execution date of U.S. Patent Application
KANAGAWA JAPAN	Execution date of 0.3. I atom Application
Residence of sixth inventor	Sept 22. 2011
Signature of sixth inventor	Date of this assignment
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Name of seventh inventor	Execution date of U.S. Patent Application
Residence of seventh inventor	
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Signature of seventh inventor	Date of this assignment
Name of eighth inventor	Execution date of U.S. Patent Application
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01 111	Deta of this againment
Signature of eighth inventor	Date of this assignment
Name of sixth investor	Execution date of U.S. Patent Application
Name of ninth inventor	Execution date of O.S. Fatent Application
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Signature of ninth inventor	Date of this assignment
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